

GaN bidirectional switch innovation and related applications

Dr. Edward A. Jones, Lead Principal Engineer, Infineon Technologies

**Bodo's
Wide Bandgap
Event 2025**

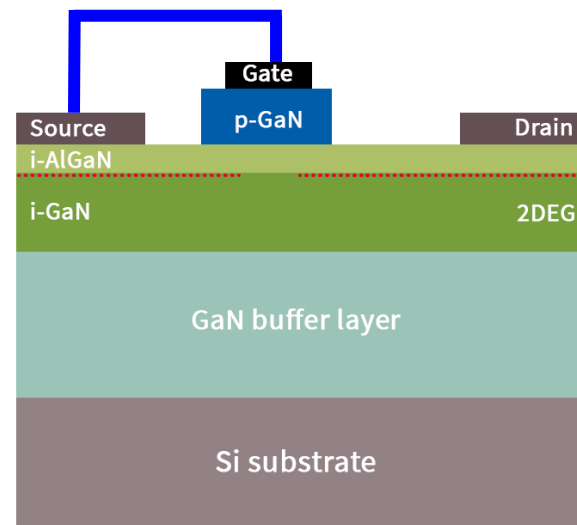
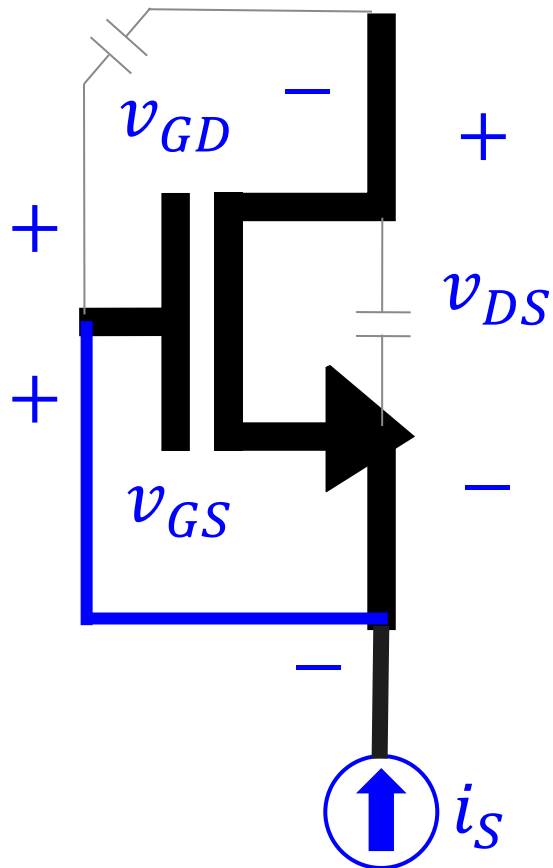
Making WBG Designs Happen

GaN

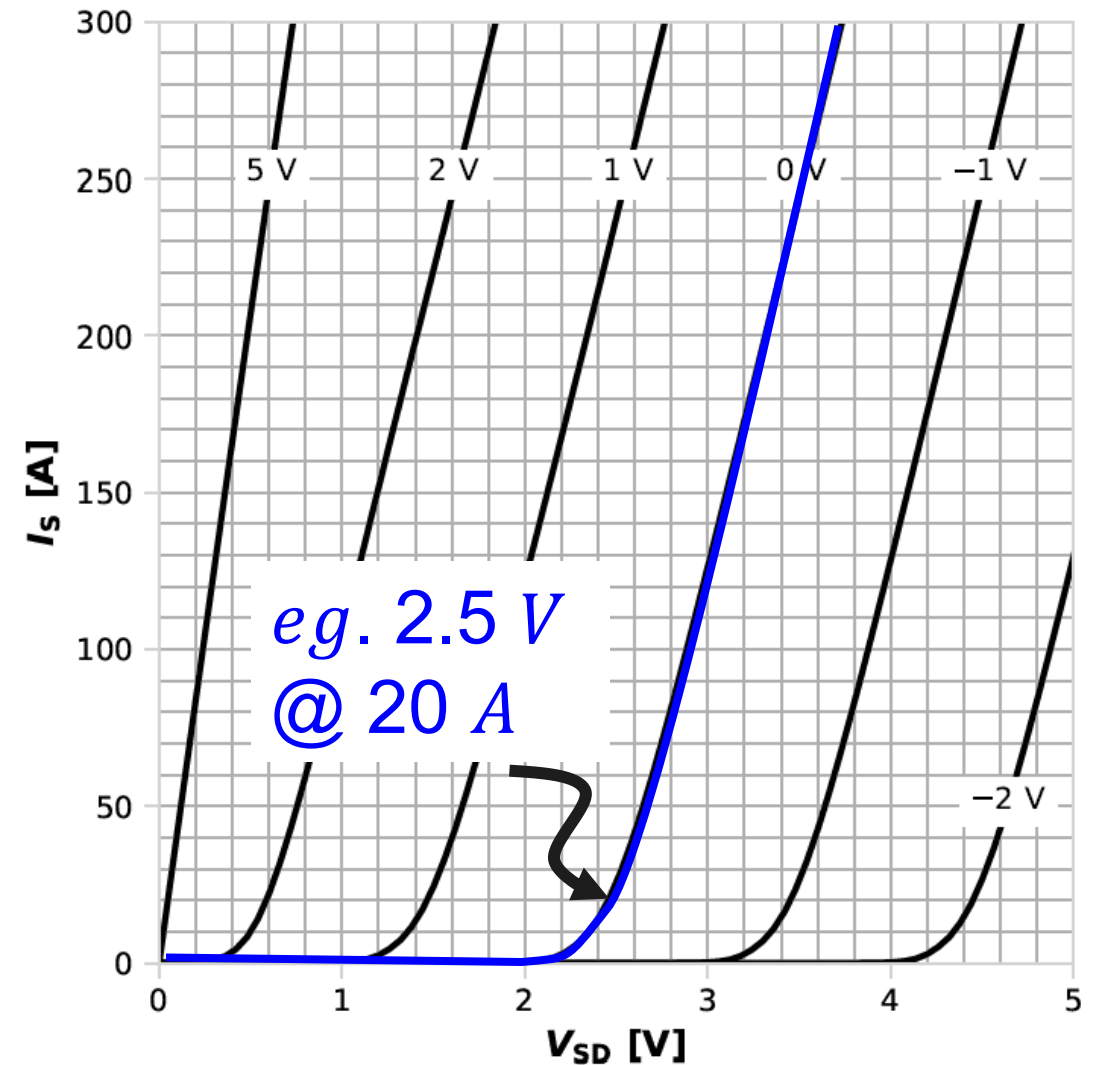
Understanding reverse conduction (body diode) behavior in GaN

$$v_{SD} = v_{GD}$$

$$V_{SD} \approx V_{PL}$$



Reverse Output Characteristic

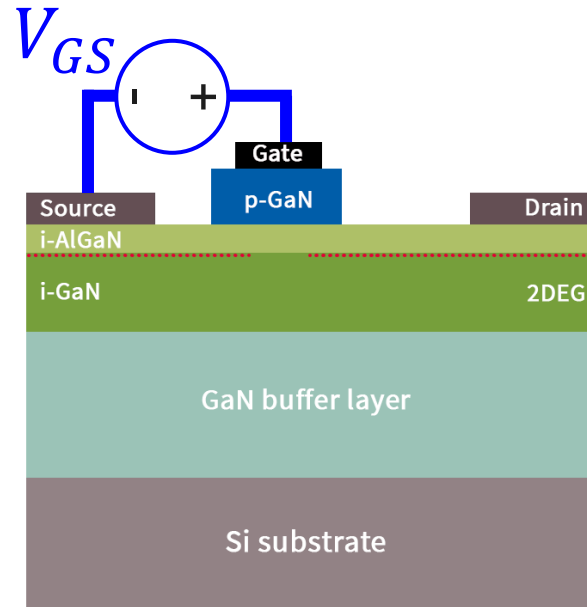
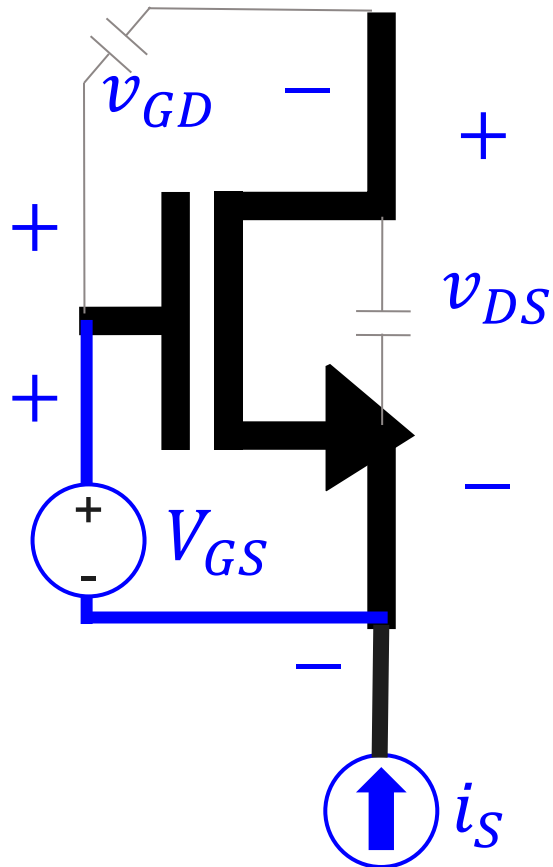


Understanding reverse conduction (body diode) behavior in GaN

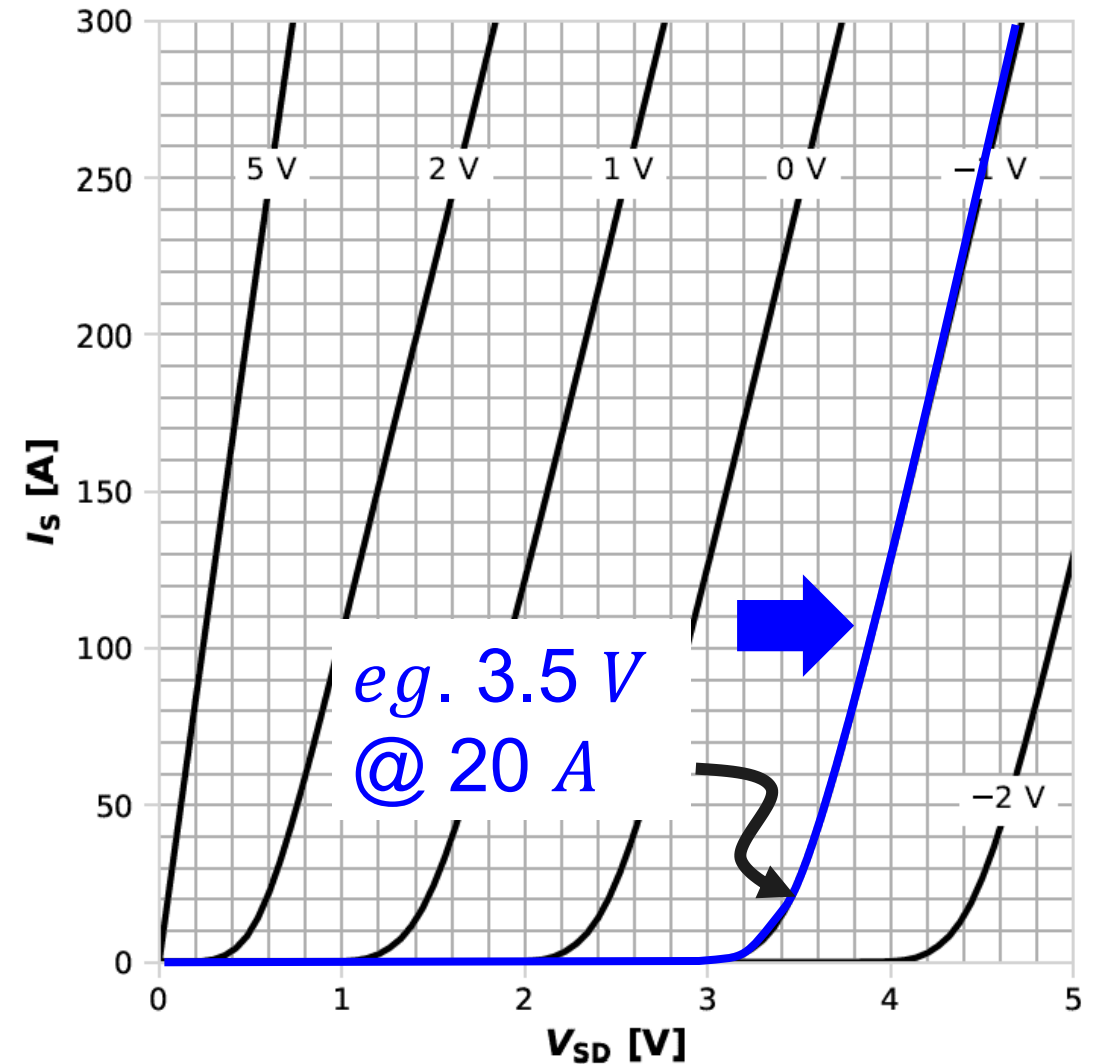
$$v_{SD} = v_{GD} - V_{GS}$$

(e.g. $V_{GS} = -1\text{ V}$)

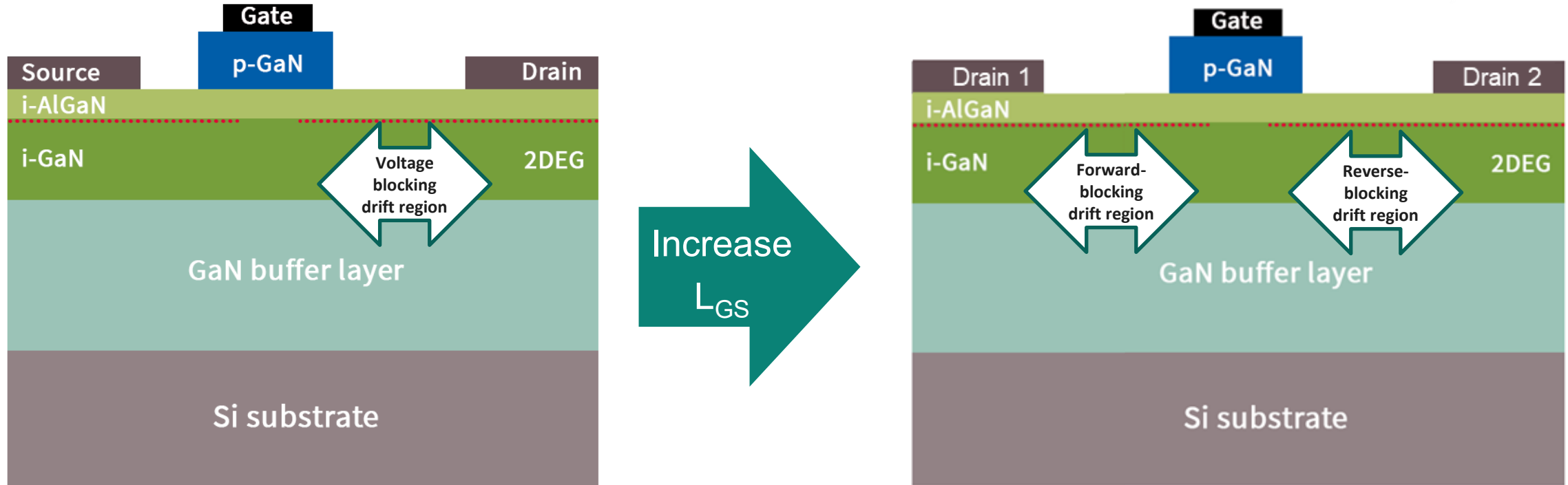
$$V_{SD} \approx V_{PL} + 1$$



Reverse Output Characteristic

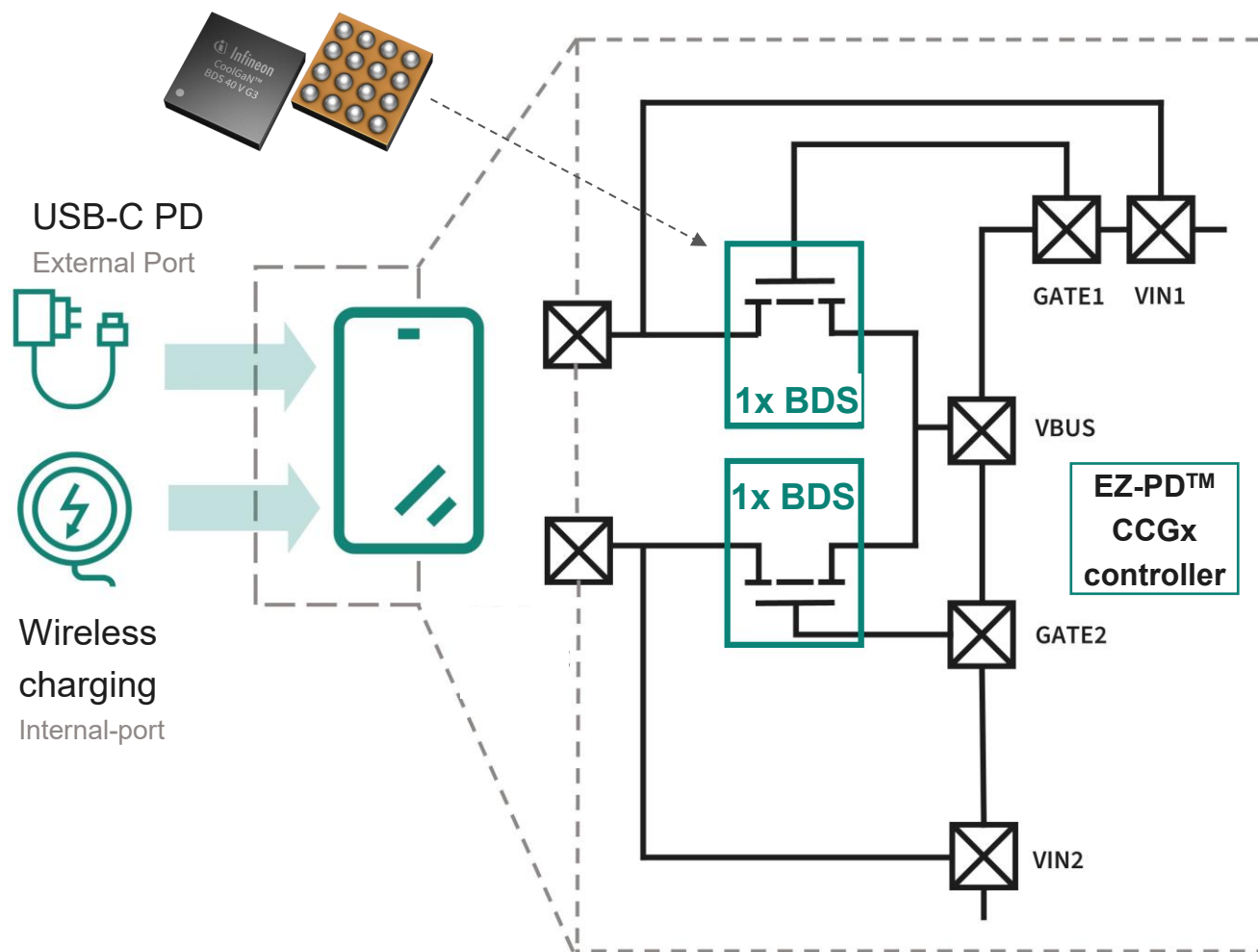


The common-source GaN BDS for low voltage static applications

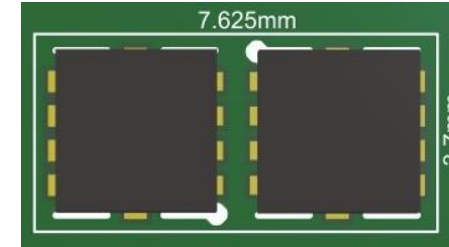


Typically ~2x less total chip area than back-to-back GaN HEMTs, even more compared to Si MOSFETs

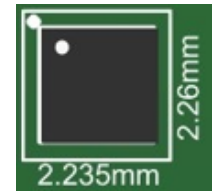
Application highlight: 40 V CoolGaN™ BDS for static battery protection (OVP) in a smart-phone



6 mΩ $R_{DD(on)}$ using back-to-back Si MOSFETs



6 mΩ $R_{DD(on)}$ using CoolGaN™ BDS



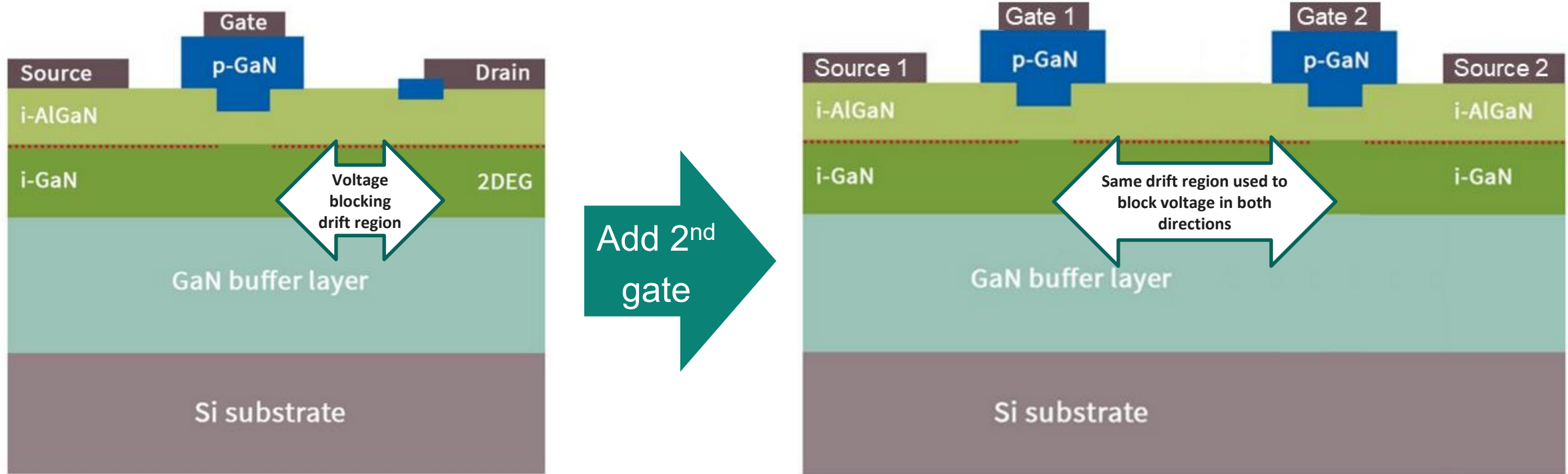
Customer use case: 82% PCB area reduction!

Functionality:

- Bidirectional current flow during ON state
- Bidirectional current and voltage blocking during OFF state (OVP protection)

- External port needs BDS: OVP USB port overvoltage protection up to 40 V (48 Vpk), after TVS diodes
- BDS used for selection of port: Power source selector (Mux) between USB and wireless charging

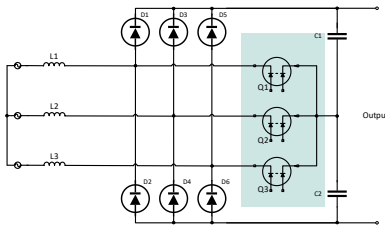
The common-drain GaN BDS for higher voltage switching applications



Typically 3~4x less total chip area than back-to-back GaN HEMTs, even more compared to Si MOSFETs

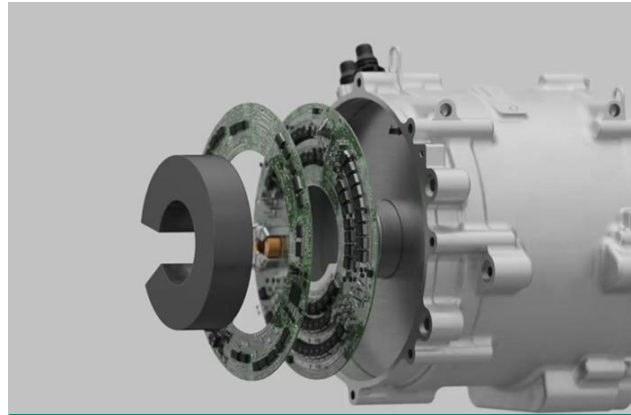
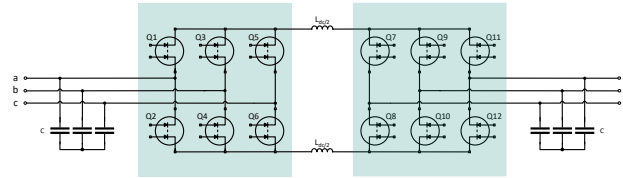
650 V CoolGaN™ BDS replacing back-to-back MOSFETs and enables new topologies (or re-enables old topologies)

Replacement of back-to-back switches in AC-DC applications



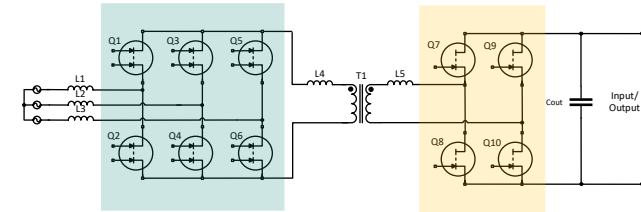
AI servers, adapters, lighting, and more

Current Source Inverters (CSI)



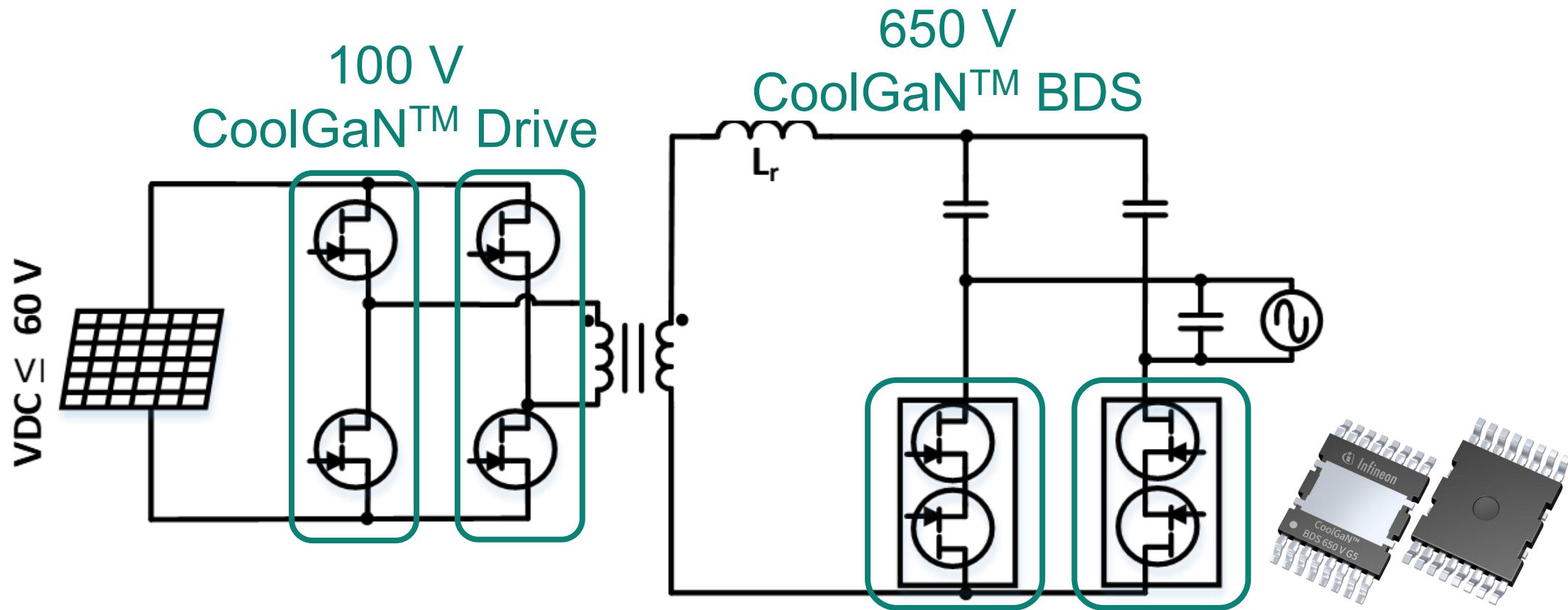
Motor drives

Single-stage AC power conversion



Solar, OBC, and more

Application highlight: CoolGaN™ BDS and CoolGaN™ Drive in photovoltaatic micro-inverters



Higher power density



Higher efficiency



Lower system cost

- New CoolGaN™ BDS already in mass production with two distinct technologies and use-cases:
 - 40 V static BDS for battery protection in consumer electronics
 - 650 V switching BDS for PV, OBC, AI data centers, etc.
- Game-changing improvements at the system level:
 - Power density
 - Efficiency
 - BOM cost
- What will be the next killer-app for bidirectional GaN?
- Who will dream it up?
- Exciting days ahead!

